TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT MULTI CHIP

# TD62M8500F

# 8CH LOW SATURATION VOLTAGE SINK DRIVER

The TD62M8500F is Multi Chip IC incorporates 8 low saturation discrete transistors equipped Fly-wheeling Diode and Bias resistor.

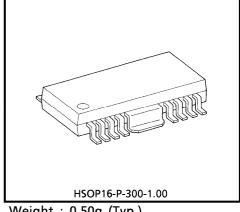
This IC is suitable for a battery use motor drive and LED display module applications.

#### **FEATURES**

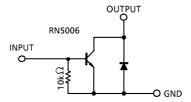
- Suitable for Motor drive circuit and LED display module
- Bias Resistor and Diodes are equipped :  $R = 10k\Omega$
- Low Saturation Voltage

$$V_{CE (sat)} = 0.16V (Typ.)$$
 at  $I_C = 1A$   
 $V_{CE (sat)} = 0.30V (Typ.)$  at  $I_C = 2A$ 

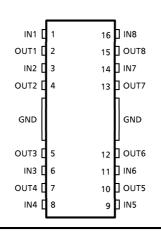
 HSOP16 pitch power small package sealed **SCHEMATIC** 



Weight: 0.50g (Typ.)



# PIN CONNECTION (TOP VIEW)



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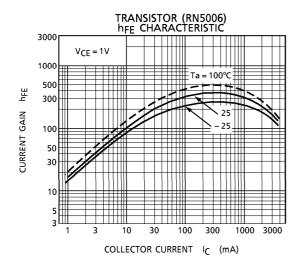
# **MAXIMUM RATINGS** (Ta = 25°C)

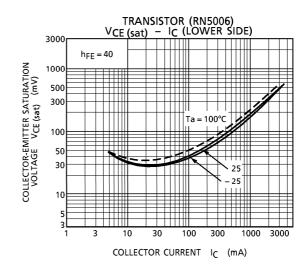
CHARACTERISTIC	SYMBOL	RATING	UNIT	
Supply Voltage	Vcc	10	V	
Breakdown Voltage	V <sub>CBO</sub>	10	V	
	VCER	10		
	V <sub>EBO</sub>	6		
Output Current	lo (AVE)	2	А	
	IO (PEAK)	(Note 1) 4		
Base Current	IB (AVE)	0.4	А	
	IB (PEAK)	0.8		
Fly-wheeling Diode Forward Current	lF	(Note 2) 2	А	
Power Dissipation	PD	900	mW	
Junction Temperature	Tj	150	°C	
Operating Temperature	T <sub>opr</sub>	<b>- 40∼85</b>	°C	
Storage Temperature	T <sub>stg</sub>	<b>- 55∼150</b>	°C	

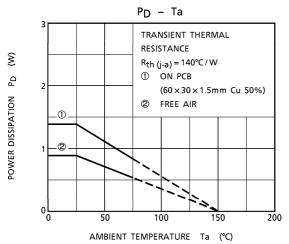
(Note 1) T = 10ms MAX. and maximum duty is less than 30%. (Note 2) T = 10ms single pulse

# **ELECTRICAL CHARACTERISTICS** (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Current Gain	h <sub>FE</sub> (1)	_	$V_{CE} = 1V, I_{C} = 0.5A$	160	_	600	_
	h <sub>FE</sub> (2)	_	V <sub>CE</sub> = 1V, I <sub>C</sub> = 1.5A	60	130	_	
		_	I <sub>C</sub> = 1A, I <sub>B</sub> = 25mA	_	0.16	0.32	V
	V <sub>CE</sub> (sat)		I <sub>C</sub> = 2A, I <sub>B</sub> = 50mA	_	0.30	0.50	
Transition Frequency	fT	<b>—</b>	$V_{CE} = 2V, I_{C} = 0.5A$	_	150	_	MHz
Leakage Current	lOL	<b>—</b>	V <sub>CC</sub> = 10V	_	0	10	μΑ
Fly-wheeling Diode Forward	\/-	V <sub>F</sub> —	I <sub>F</sub> = 300mA	_	0.18	1.5	V
Voltage	*F		I <sub>F</sub> = 450mA, 10ms	_	1.90	_	
Base-Emitter Resistor	R <sub>BE</sub>	_	_	7	10	13	kΩ
Base-Emitter Forward Voltage	V <sub>BE</sub>	_	V <sub>CE</sub> = 1V, I <sub>C</sub> = 2.0A	_	0.84	1.5	V







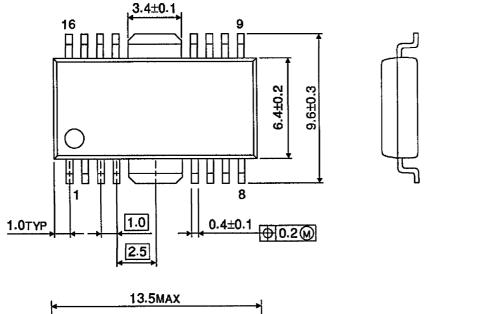
#### PRECAUTIONS for USING

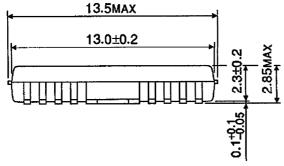
Utmost care is necessary in the design of the output line, V<sub>CC</sub> and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

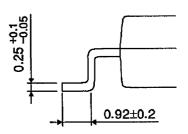
# **OUTLINE DRAWING**

HSOP16-P-300-1.00

Unit: mm







Weight: 0.50g (Typ.)